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**CHT-NEPTUNE  
PRELIMINARY DATASHEET**

Version: 4.0

**High Temperature  
1200V/10A, Silicon Carbide MOSFET**

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**General description**

CHT-NEPTUNE is an High Temperature, High Voltage, Silicon Carbide MOSFET switch. It is available in a metal TO-257 package – the metal case being electrically isolated from the switch terminals. The product is guaranteed for normal operation on the full range -55°C to +225°C. The device has a breakdown voltage in excess of 1200V and is capable of switching currents up to 10A at the maximum temperature (225°C). The device features a body diode that can be used as free-wheeling diode.

This new version D (PLA8543D), replacing obsolete version C (PLA8543C), offers lower On Resistance with equivalent switching energies.

**Benefits**

- High Temperature Operation
- Extended lifetime and high reliability
- Low Switching Energy enabling High Frequency Switching
- Pins electrically isolated from the case easing mechanical and thermal integration Seamless driving with HADES<sup>®</sup> gate driver solutions

**Features**

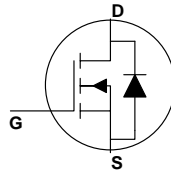
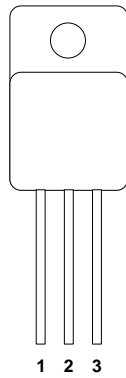
- Specified from -55 to +225°C (Tj)
- $V_{DS}$  Max: 1200V
- $I_{DS}$  Max (continuous):
  - 10A @ 225°C (Tj)
- Typical On-resistance:
  - $R_{DSon}$ = 40 mΩ @ 25°C
  - $R_{DSon}$ = 120 mΩ @ 225°C
- Low Switching Energy
  - $E_{on}$ = 240μJ
  - $E_{off}$ = 140μJ
- Voltage control:  $V_{GS}$ =-4V/20V
- Gate charge:  $Q_{GS}$ =22nC
- Low capacitance:  $C_{OSS}$ =76 pF
- Package: TO-257

**Applications**

- High Temperature, High Power Density and Extended Lifetime Power Converters
- DC-AC Converters for motor drives & actuator controls
- DC-DC converters
- AC-DC converters and battery chargers

### Package Configuration

FRONT VIEW



TO-257 (Pin1= Drain; Pin2= Source; Pin3= Gate) (case floating)

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**Absolute Maximum Ratings**

Gate-to-Source voltage $V_{GS}$	-5V to 22V
Drain-to-Source voltage $V_{DS}$	-0.5V to 1200V
Max DC Drain current $I_{DS}$	12A
Max Junction temperature $T_{jmax}$	225°C
Power dissipation (*)	30W

**Operating Conditions**

Gate-to-Source voltage $V_{GS}$	-4V to 20V
Drain-to-Source voltage $V_{DS}$	-0.5V to 1200V
Max DC drain current $I_{DS}$	10A
Max pulsed drain current	10A
Junction temperature	-55°C to +225°C

**ESD Rating** (expected)

Human Body Model	>1kV
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(\*): including switching losses

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## Electrical characteristics

Unless otherwise stated,  $T_j = 25^\circ\text{C}$ . **Bold** figures point out values valid over the whole temperature range ( $T_j = -55^\circ\text{C}$  to  $+225^\circ\text{C}$ ).

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Threshold voltage	$V_{TH}$	$T_j = 25^\circ\text{C}$ ; $I_D = 1\text{mA}$ ; $V_{DS} = 20\text{V}$		4.45		V
		$T_j = 225^\circ\text{C}$ ; $I_D = 1\text{mA}$ ; $V_{DS} = 20\text{V}$		3.28		V
Drain cut-off current	$I_{DSS}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 1200\text{V}$ , $T_j = 25^\circ\text{C}$		20		nA
		$V_{GS} = 0\text{V}$ , $V_{DS} = 1200\text{V}$ , $T_j = 225^\circ\text{C}$		10		$\mu\text{A}$
		$V_{GS} = -5\text{V}$ , $V_{DS} = 1200\text{V}$ , $T_j = 225^\circ\text{C}$		0.5		$\mu\text{A}$
Gate leakage current	$I_{GSS}$	$V_{GS} = 20\text{V}$ , $V_{DS} = 0\text{V}$ , $T_j = 25^\circ\text{C}$		5		nA
		$V_{GS} = 20\text{V}$ , $V_{DS} = 0\text{V}$ , $T_j = 225^\circ\text{C}$		20		nA
Static drain-to-source resistance	$R_{DS(on)}$	$V_{GS} = 20\text{V}$ , $I_D = 10\text{A}$ , $T_j = 25^\circ\text{C}$		40		$\text{m}\Omega$
		$V_{GS} = 20\text{V}$ , $I_D = 10\text{A}$ , $T_j = 225^\circ\text{C}$		120		$\text{m}\Omega$
Breakdown drain-to-source voltage (DC characterization)	$V_{BRDS}$	$V_{GS} = 0\text{V}$ ; $I_D = 100 \mu\text{A}$	<b>1200</b>			V
Input capacitance	$C_{ISS}$	$V_{GS} = 0\text{V}_{DC}$ , $V_{DS} = 600\text{V}_{DC}$ $f = 1 \text{MHz}$		1337		pF
Output capacitance	$C_{OSS}$	$V_{AC} = 25\text{mV}$		76		pF
Feedback capacitance	$C_{RSS}$			27		pF
Turn-on delay time	$T_{d(ON)}$	$V_{DS} = 600\text{V}$ ; $V_{GS} = -4/20\text{V}$ ; $I_D = 10\text{A}$ ; $R_G = 6.8\Omega$ ; $L = 856\mu\text{H}$		21		ns
Rise time	$T_r$			39		ns
Turn-off delay time	$T_{d(OFF)}$			49		ns
Fall time	$T_f$			24		ns
Turn-On Switching Loss	$E_{on}$			240		$\mu\text{J}$
Turn-Off Switching Loss	$E_{off}$			140		$\mu\text{J}$
Internal gate resistance	$R_G$		$V_{GS} = 0\text{V}_{DC}$ ; $f = 1 \text{MHz}$ ; $V_{AC} = 25\text{mV}$		7	
Gate to Source Charge	$Q_{GS}$	$T_j = 25^\circ\text{C}$ ; $V_{DS} = 600\text{V}$ ; $I_D = 10\text{A}$ ; $V_{GS} = -4/20\text{V}$		22		nC
Gate to Drain Charge	$Q_{GD}$			41		nC
Total Gate Charge	$Q_G$			107		nC

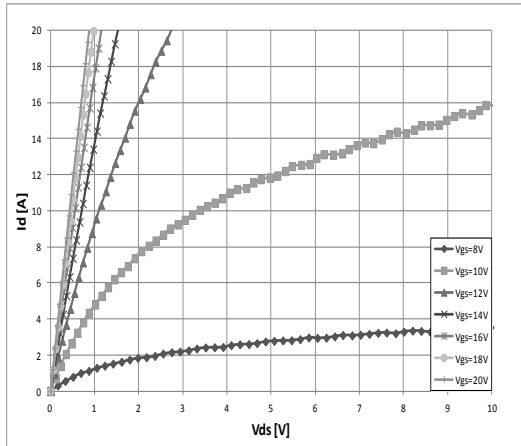
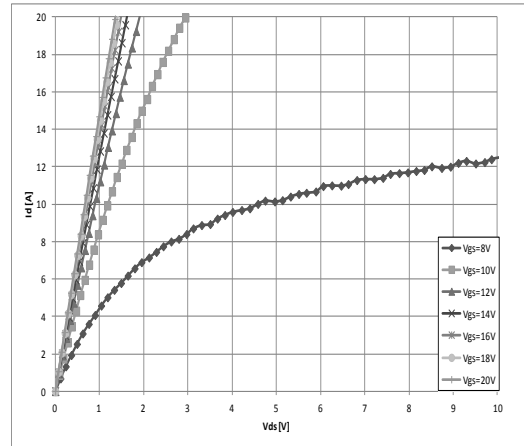
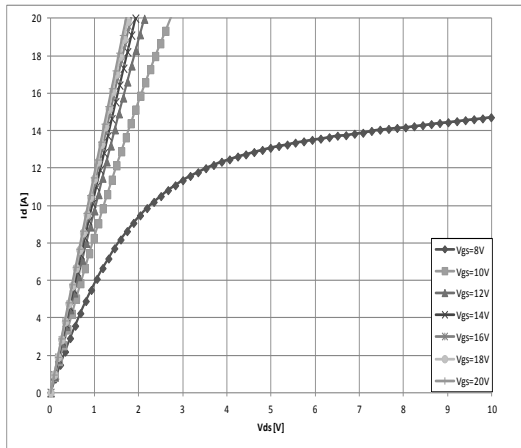
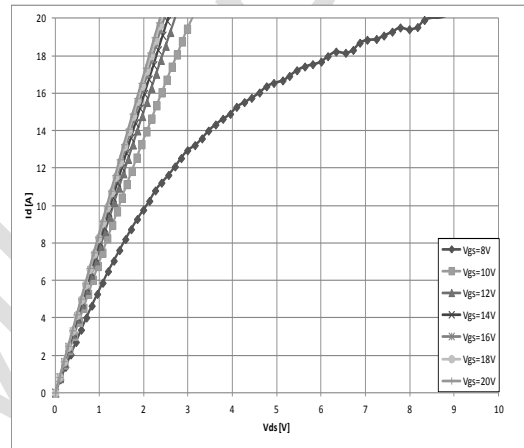
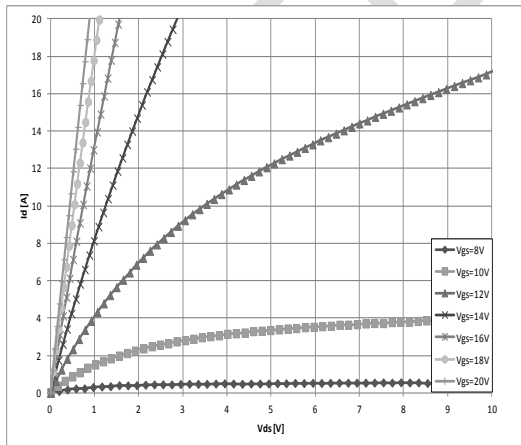
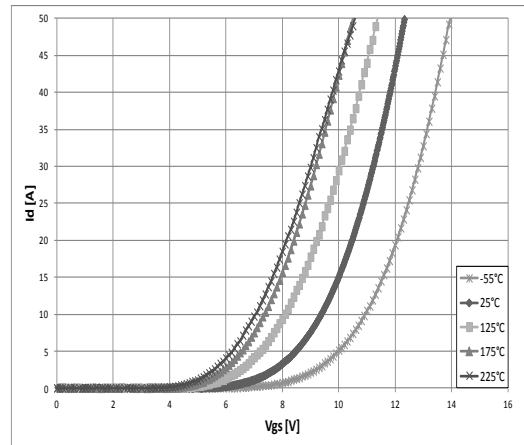
## Thermal Characteristics

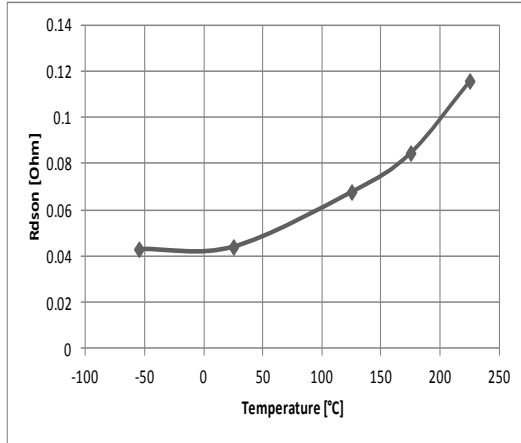
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Junction-to-Case Thermal resistance	$R_{\theta JC}$			1.1		$^\circ\text{C/W}$

## Reverse Diode Characteristics

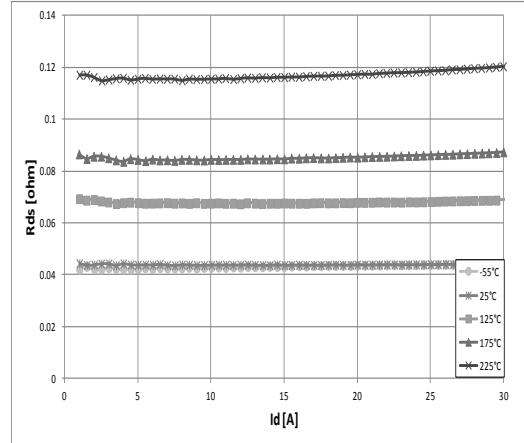
Unless otherwise stated,  $T_j = 25^\circ\text{C}$ . **Bold** figures point out values valid over the whole temperature range ( $T_j = -55^\circ\text{C}$  to  $+225^\circ\text{C}$ ). Timing definitions according to JEDEC 24 page 27

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Diode forward voltage	$V_F$	$T_j = 25^\circ\text{C}$ ; $V_{GS} = -5\text{V}$ ; $I_F = 10\text{A}$		3.6		V
		$T_j = 25^\circ\text{C}$ ; $V_{GS} = 0\text{V}$ ; $I_F = 10\text{A}$		2.7		V
Reverse recovery time	$T_{rr}$	$T_j = 25^\circ\text{C}$ ; $V_{DS} = 600\text{V}$ ;		25		ns
Peak reverse recovery current	$I_{pr}$	$I_F = 20\text{A}$ ; $di_F/dt = 1100\text{A}/\mu\text{S}$		9		A

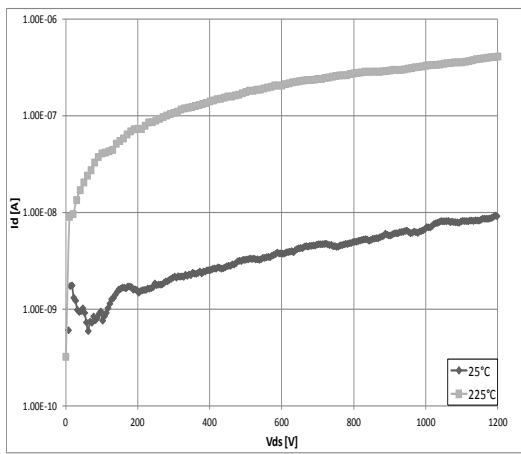
**Typical Performance Characteristics**

**Figure 1: Drain current vs  $V_{DS}$  ( $T_j=25^\circ\text{C}$ )**

**Figure 2: Drain current vs  $V_{DS}$  ( $T_j=125^\circ\text{C}$ )**

**Figure 3: Drain current vs  $V_{DS}$  ( $T_j=175^\circ\text{C}$ )**

**Figure 4: Drain current vs  $V_{DS}$  ( $T_j=225^\circ\text{C}$ )**

**Figure 5: Drain current vs  $V_{DS}$  ( $T_j=-55^\circ\text{C}$ )**

**Figure 6: Drain current vs  $V_{GS}$  voltage ( $V_{DS}=10\text{V}$ )**



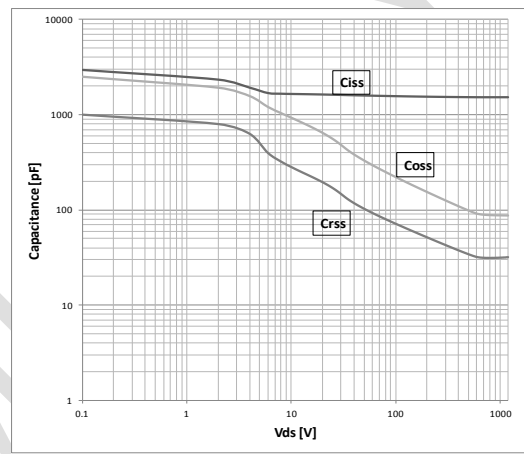
**Figure 7:** On-state drain source resistance vs. Temperature ( $V_{GS} = 20V$ ;  $I_{DS} = 10A$ )



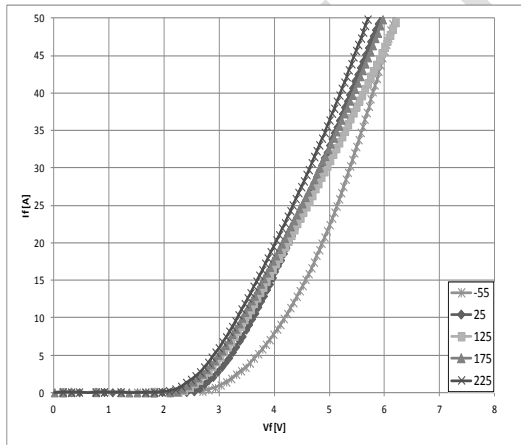
**Figure 8:** On-state drain source resistance vs. Drain current and temperature ( $V_{GS} = 20V$ )



**Figure 9:** Drain current vs  $V_{DS}$  ( $V_{GS} = -5V$ )

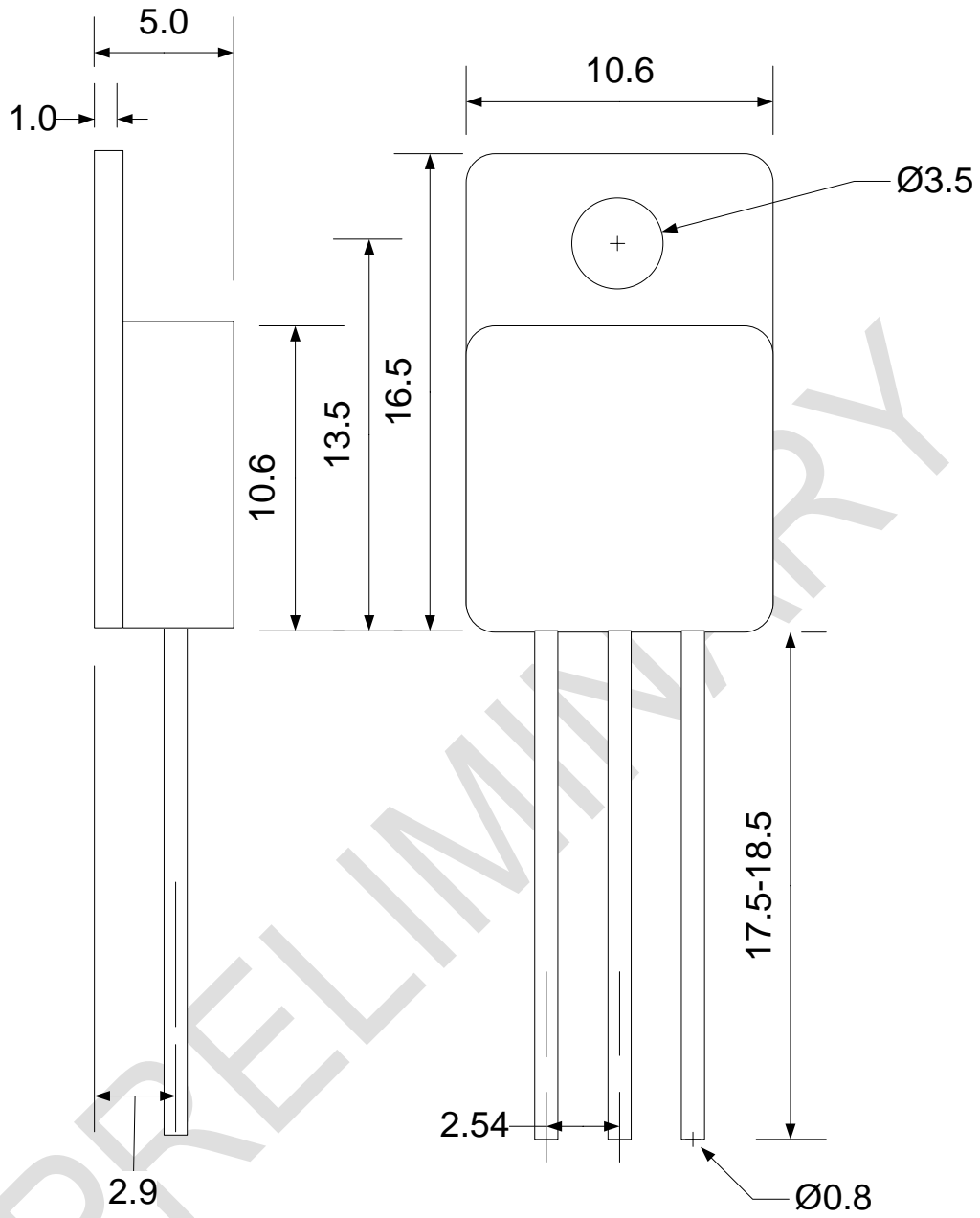


**Figure 10:** Typical capacitances vs  $V_{DS}$  ( $T_j = 25^\circ C$ )



**Figure 11:** Diode  $I_F$  vs  $V_F$  ( $V_{GS} = -5V$ )

Package Dimensions



Drawing TO257 (mm)

## Ordering Information

Product Name	Ordering Reference	Package	Marking
CHT-NEPTUNE	CHT-PLA8543D-TO257-T	TO-257 metal can	CHT-PLA8543D

## Contact & Ordering

### CISSOID S.A.

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